

STANDARD RECOVERY DIODES

Hockey Puk Version

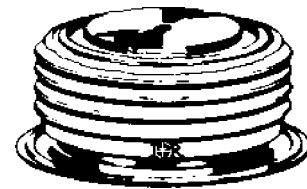
Features

- Wide current range
- High voltage ratings up to 3200V
- High surge current capabilities
- Diffused junction
- Hockey Puk version
- Case style DO-200AB (B-PUK)

1170A

Typical Applications

- Converters
- Power supplies
- Machine tool controls
- High power drives
- Medium traction applications



case style DO-200AB (B-PUK)

Major Ratings and Characteristics

Parameters	SD1100C..L		Units	
	04 to 20	25 to 32		
$I_{F(AV)}$	1170	910	A	
@ T_{hs}	55	55	°C	
$I_{F(RMS)}$	2080	1660	A	
@ T_{hs}	25	25	°C	
I_{FSM}	@ 50Hz	13000	10500	A
	@ 60Hz	13600	11000	A
I^2t	@ 50Hz	846	551	KA ² s
	@ 60Hz	772	503	KA ² s
V_{RRM} range	400to 2000	2500 to 3200	V	
T_J	- 40 to 180	- 40 to 150	°C	

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM} max. @ $T_J = T_J$ max. mA
SD1100C..L	04	400	500	15
	08	800	900	
	12	1200	1300	
	16	1600	1700	
	20	2000	2100	
	25	2500	2600	
	30	3000	3100	
	32	3200	3300	

Forward Conduction

Parameter		SD1100C..L		Units	Conditions		
		04 to 20	25 to 32				
$I_{F(AV)}$	Max. average forward current @ Heatsink temperature	1170(600)	910(420)	A	180° conduction, half sine wave Double side (single side) cooled		
		55(85)	55(85)	°C			
$I_{F(RMS)}$	Max. RMS forward current	2080	1660	A	@ 25°C heatsink temperature double side cooled		
I_{FSM}	Max. peak, one-cycle forward, non-repetitive surge current	13000	10500	A	t = 10ms	No voltage	Sinusoidal halfwave, Initial $T_J = T_J$ max.
		13600	11000		t = 8.3ms	reapplied	
		10930	8830		t = 10ms	100% V_{RRM}	
		11450	9250		t = 8.3ms	reapplied	
I^2t	Maximum I^2t for fusing	846	551	KA ² s	t = 10ms	No voltage	
		772	503		t = 8.3ms	reapplied	
		598	390		t = 10ms	100% V_{RRM}	
		546	356		t = 8.3ms	reapplied	
$I^2\sqrt{t}$	Maximum $I^2\sqrt{t}$ for fusing	8460	5510	KA ² /s	t = 0.1 to 10ms, no voltage reapplied		
$V_{F(TO)1}$	Low level value of threshold voltage	0.78	0.84	V	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.		
$V_{F(TO)2}$	High level value of threshold voltage	0.94	0.88		(I $> \pi \times I_{F(AV)}$), $T_J = T_J$ max.		
r_{f1}	Low level value of forward slope resistance	0.35	0.40	mΩ	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.		
r_{f2}	High level value of forward slope resistance	0.26	0.38		(I $> \pi \times I_{F(AV)}$), $T_J = T_J$ max.		
V_{FM}	Max. forward voltage drop	1.31	1.44	V	$I_{pk} = 1500A$, $T_J = T_J$ max, $t_p = 10ms$ sinusoidal wave		

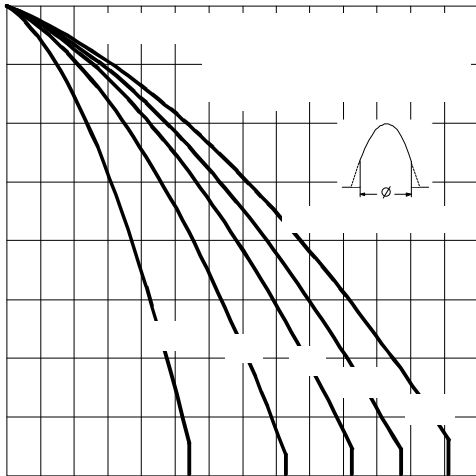


Fig. 3 - Current Ratings Characteristics

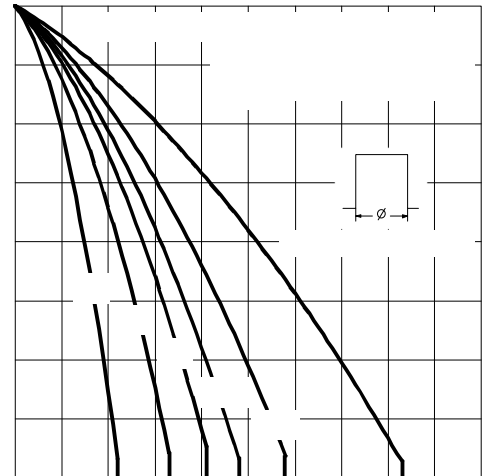


Fig. 4 - Current Ratings Characteristics

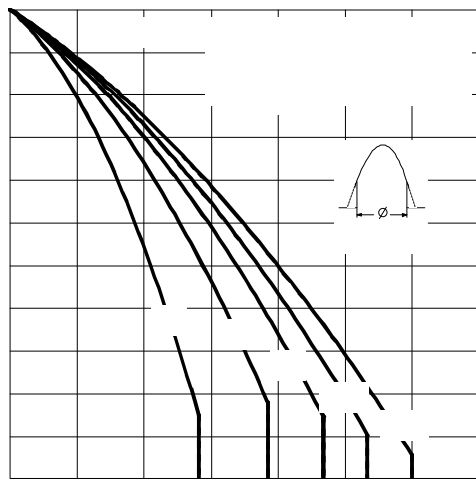


Fig. 5 - Current Ratings Characteristics

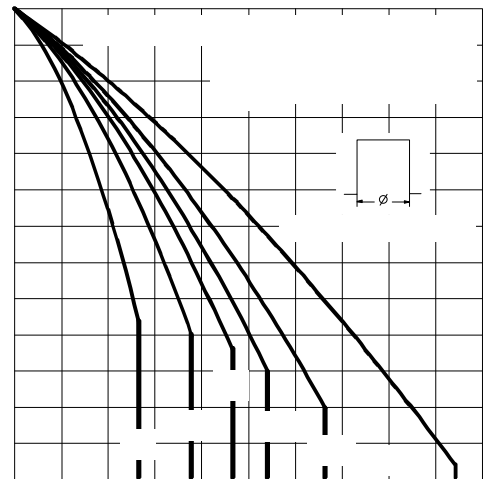


Fig. 6 - Current Ratings Characteristics

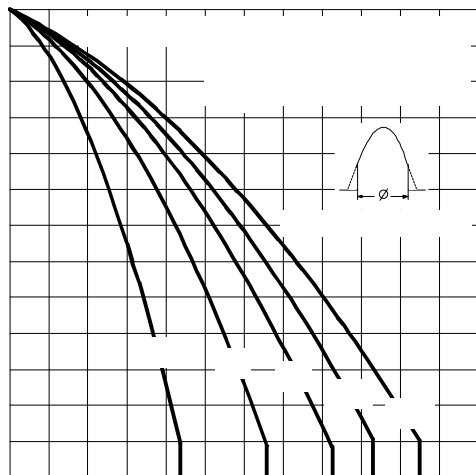


Fig. 7 - Current Ratings Characteristics

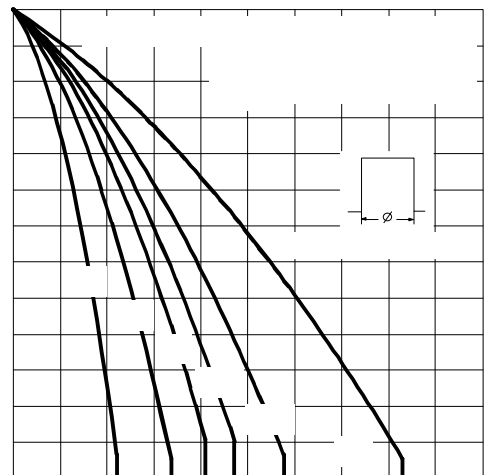


Fig. 8 - Current Ratings Characteristics

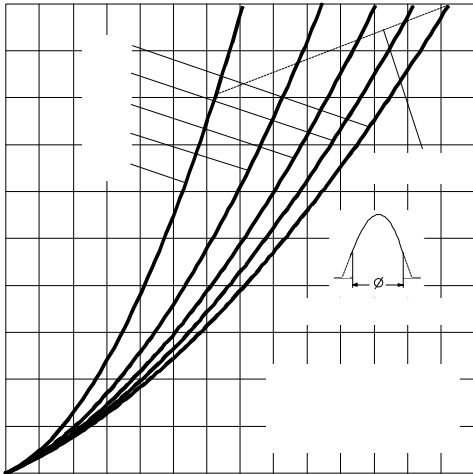


Fig. 9 - Forward Power Loss Characteristics

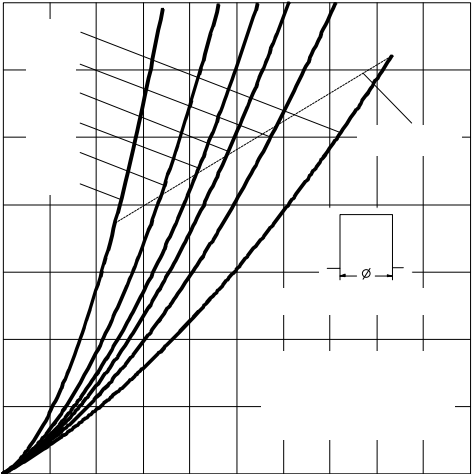


Fig. 10 - Forward Power Loss Characteristics

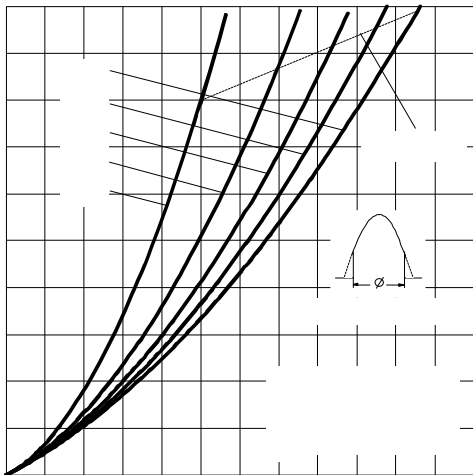


Fig. 11 - Forward Power Loss Characteristics

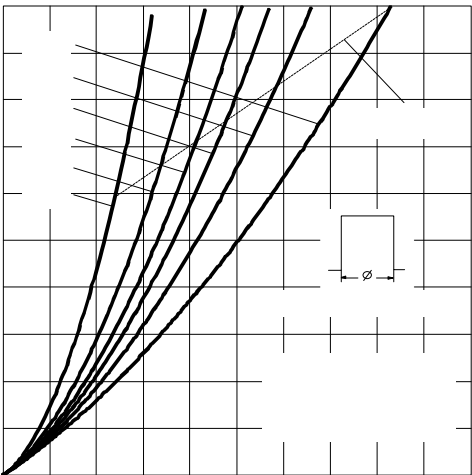


Fig. 12 - Forward Power Loss Characteristics

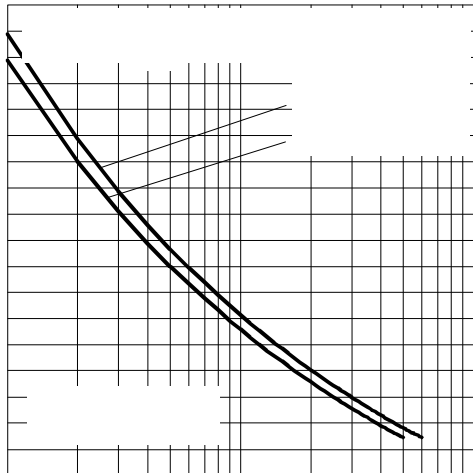


Fig. 13 - Maximum Non-Repetitive Surge Current

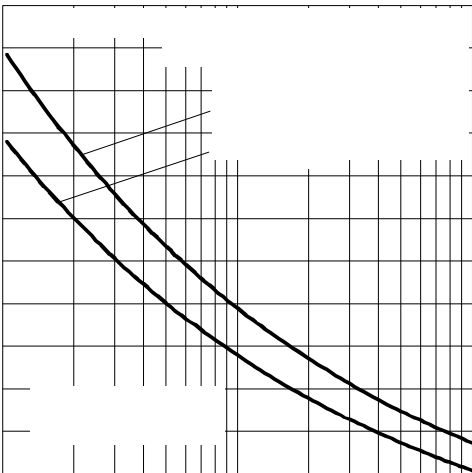


Fig. 14 - Maximum Non-Repetitive Surge Current

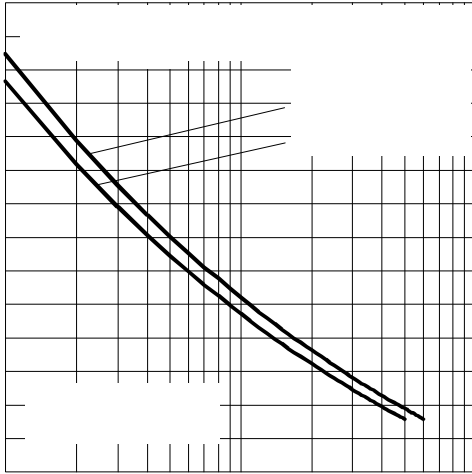


Fig. 15 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

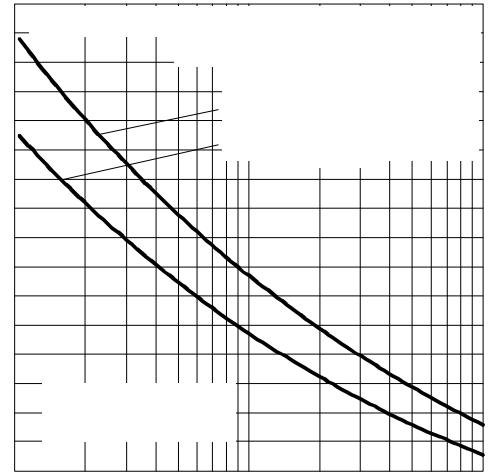


Fig. 16 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

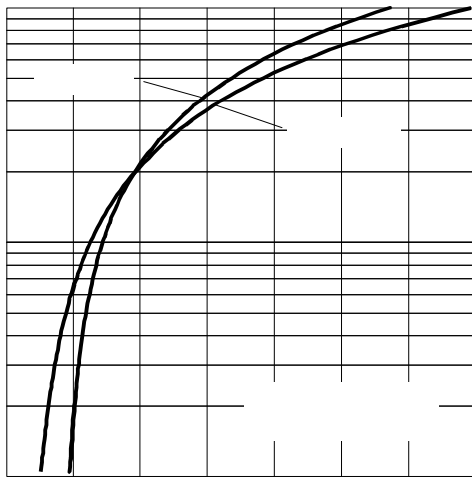


Fig. 17 - Forward Voltage Drop Characteristics

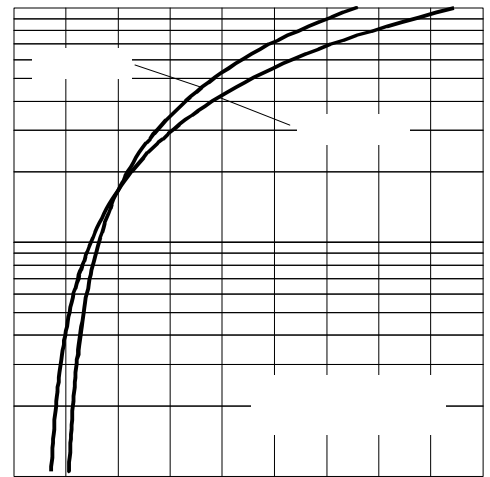


Fig. 18 - Forward Voltage Drop Characteristics

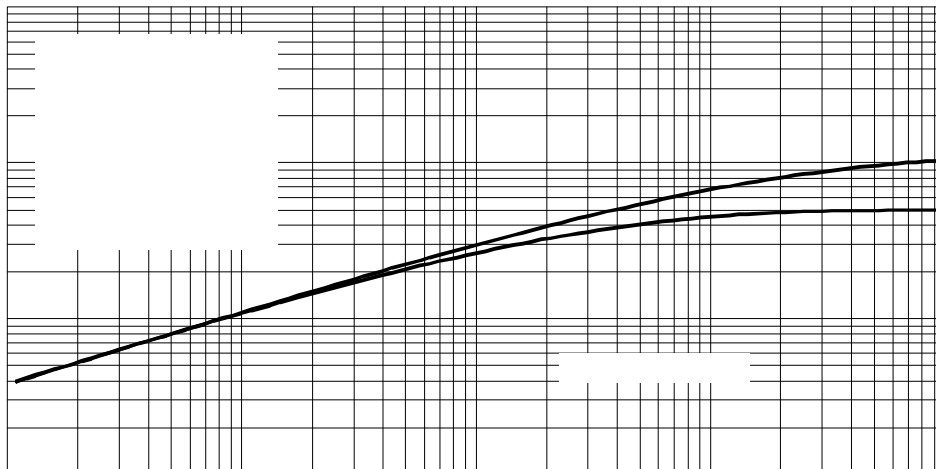


Fig. 19 - Thermal Impedance Z_{thJC} Characteristics

Thermal and Mechanical Specifications

Parameter	SD1100C..L		Units	Conditions
	04 to 20	25 to 32		
T_J Max. junction operating temperature range	-40 to 180	-40 to 150	°C	
T_{stg} Max. storage temperature range	-55 to 200	-55 to 200		
R_{thJ-hs} Max. thermal resistance, junction to heatsink	0.11 0.05		K/W	DC operation single side cooled DC operation double side cooled
F Mounting force, $\pm 10\%$	9800 (1000)		N (Kg)	
wt Approximate weight	250		g	
Case style	DO-200AB (B-PUK)		See Outline Table	

 ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.011	0.011	0.008	0.008	K/W	$T_J = T_J \text{ max.}$
120°	0.014	0.015	0.014	0.014		
90°	0.018	0.018	0.019	0.019		
60°	0.026	0.026	0.027	0.028		
30°	0.045	0.046	0.046	0.046		

Ordering Information Table

Device Code	
1	- Diode
2	- Essential part number
3	- 0 = Standard recovery
4	- C = Ceramic Puk
5	- Voltage code: Code x 100 = V_{RRM} (See Voltage Ratings table)
6	- L = Puk Case DO-200AB (B-PUK)

Outline Table

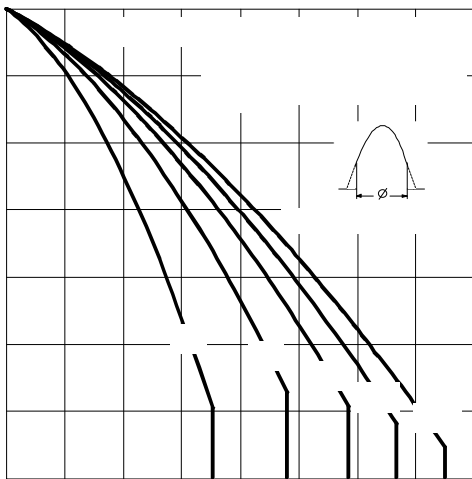
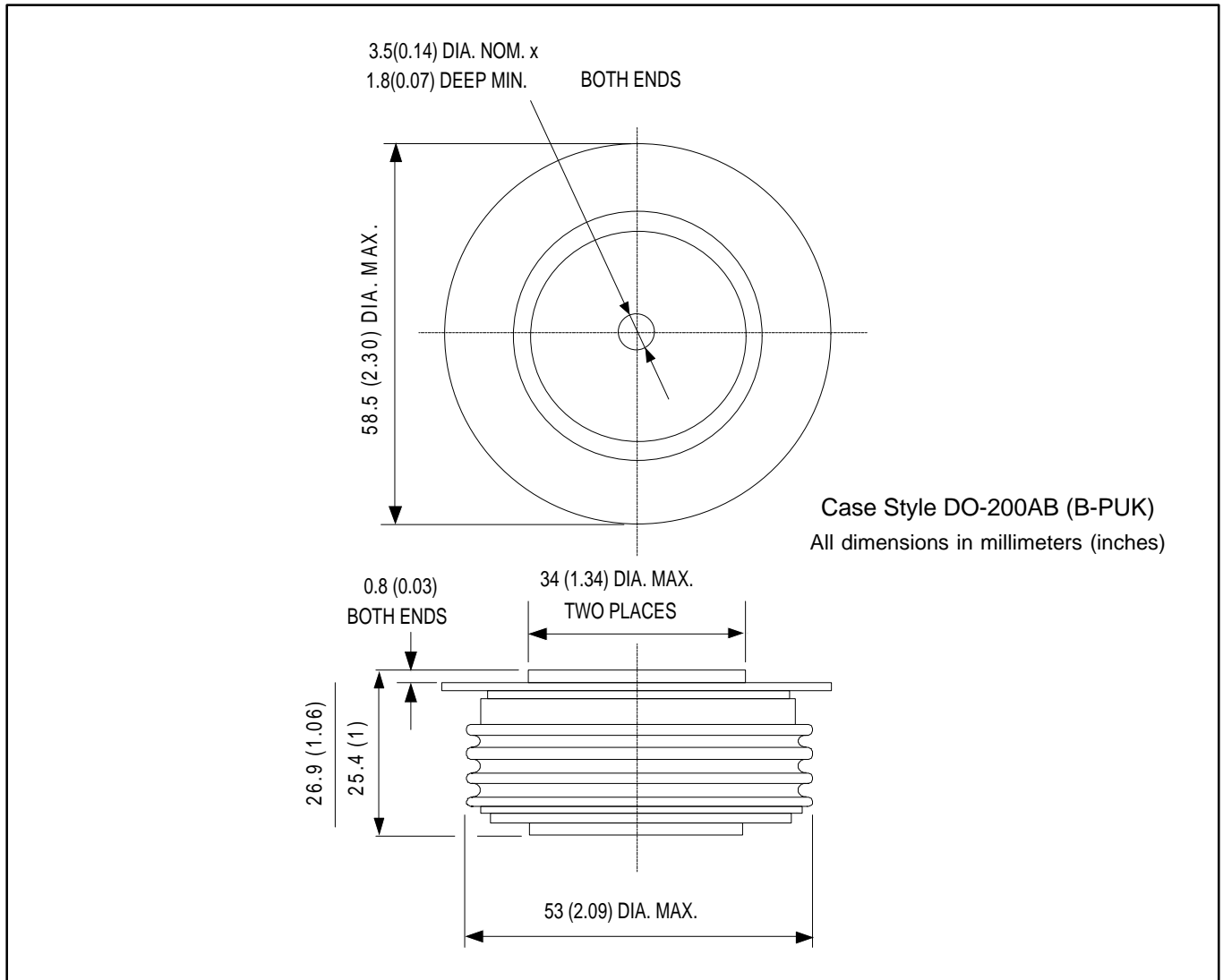


Fig. 1 - Current Ratings Characteristics

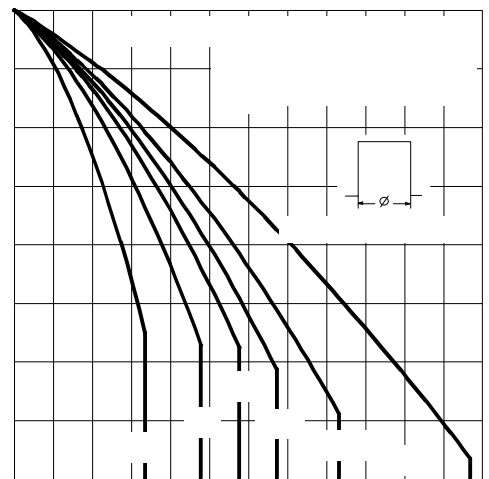


Fig. 2 - Current Ratings Characteristics